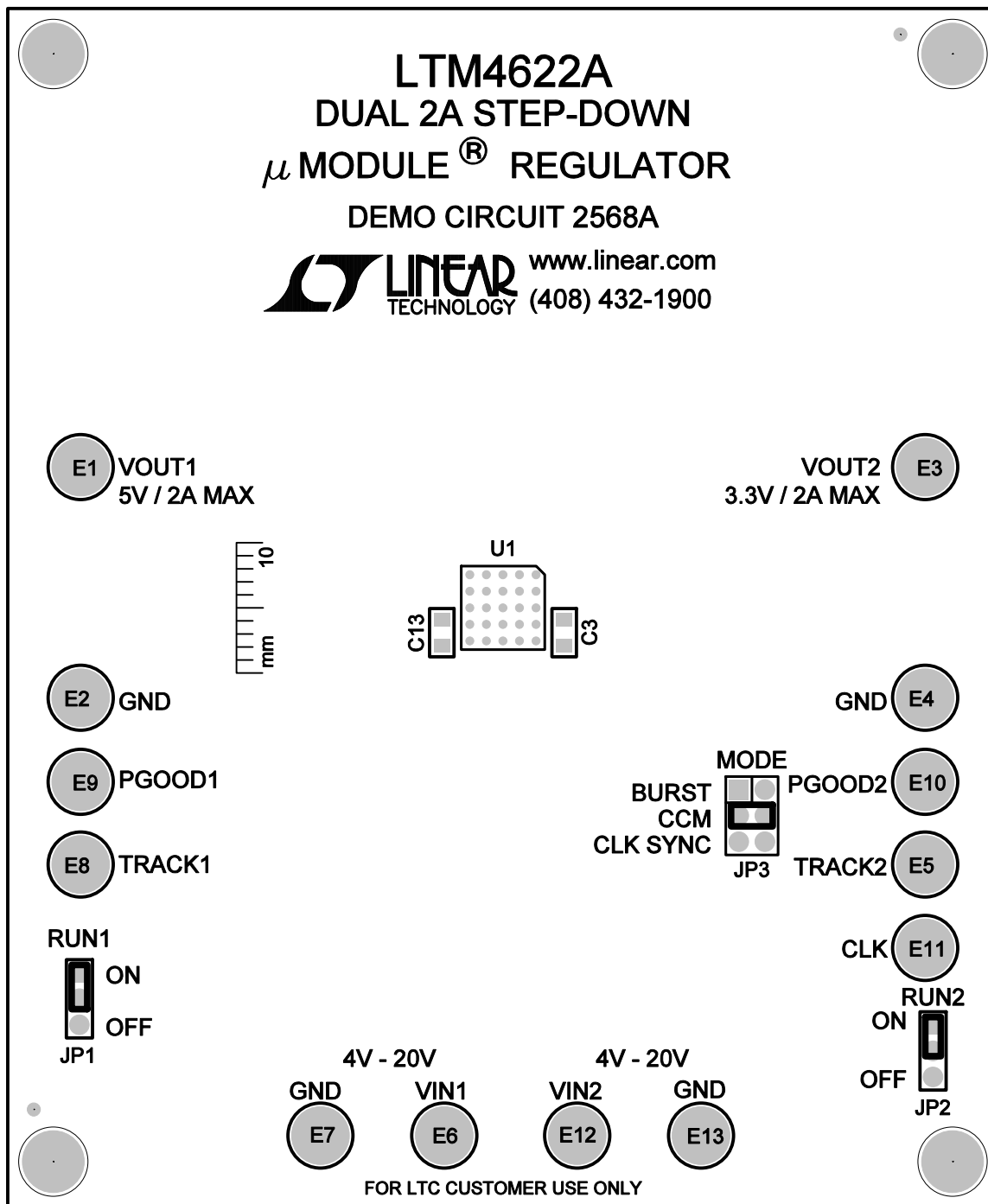


## NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS: REFLOW SOLDER TOP SIDE SMD.  
MAXIMUM SOLDER TEMPERATURE IS 240 DEG. C.
3. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS WHERE SHOWN .
5. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP  
TO ANY BOARD.



**LINEAR TECHNOLOGY CORPORATION**

DC2568A REV 2  
08/29/16

TOP SILKSCREEN  
TOP ASSEMBLY